# MCCOVAVES & REF

**News** 

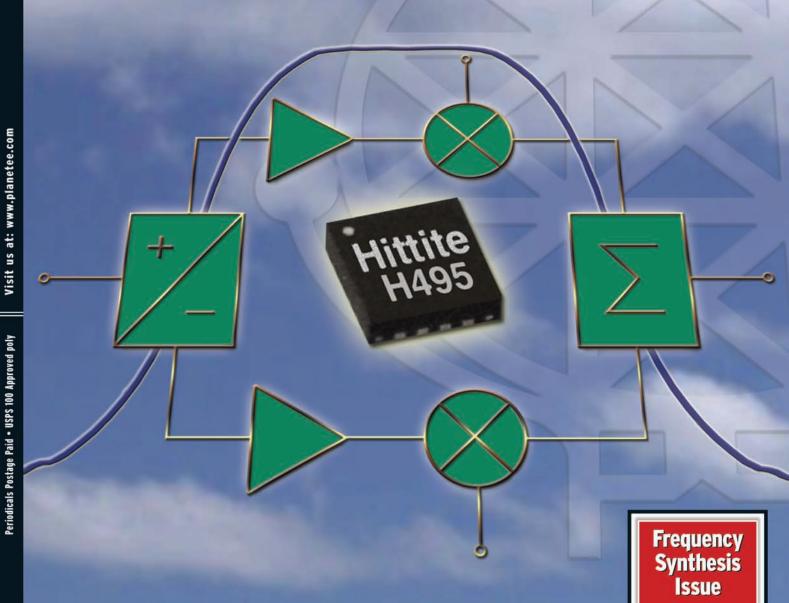
**Design Feature** 

Product Technology

Surveying advanced frequency synthesizers Smart synthesizers simplify RF integration

C/N generators cover 0.8 to 6.0 GHz

## SiGe Direct Modulators Span Wide Dynamic Range



#### cover story

### SiGe Direct Modulators Ease Upconverter Design

These efficient direct quadrature modulators support digital modulation formats with I and Q bandwidths as wide as 250 MHz for carrier frequencies from 250 to 7000 MHz.

irect quadrature modulators provide many benefits to transceiver/transmitter designers working with modern digital-modulation formats. Compared to superheterodyne upconversion approaches, direct quadrature modulation enables simpler, smaller designs at lower costs. With advances in RF integrated circuit (RF IC) and silicon-germanium (SiGe) process technologies, the engineers at Hittite Microwave have succeeded in bringing direct quadrature modulator components to a new

level, extending direct modulation to 7 GHz. The company's models HMC495LP3 and HMC496LP3 SiGe direct quadrature modulators work

from 250 to 3800 MHz and from 4.0 to 7.0 GHz, respectively, housed in compact 3 × 3-mm leadless surface-mount packages. With these modulators, designers can simplify a transmit-signal chain by eliminating one mixer stage, along with its associated matching, filtering, voltage-controlled oscillator (VCO), phase-locked loop (PLL),



1. The HMC495LP3 and HMC496LP3 direct quadrature modulators are supplied in compact, 3  $\times$  3-mm leadless surface-mount packages.

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and LO buffering circuitry.

The HMC495LP3 and HMC496LP3 wideband SiGe direct quadrature modulators (Fig. 1) are based on high-frequency SiGe heterojunction-bipolar-transistor (HBT) technology. The silicon semiconductor process supports high-level integration at extremely high transition frequencies and with relatively low power consumption. The lower-

frequency HMC495LP3 is suitable for Global System for Mobile Communications (GSM), code-division multiple access (CDMA), wideband CDMA (WCDMA), personal handyphone system (PHS), fixed-wireless, MMDS, and wireless-local-loop (WLL) systems. The higher-frequency HMC496LP3 serves IEEE 802.11a wireless-local-area-network (WLAN), UNII, and microwave radio applications.

The HMC495LP3 employs a polyphase network which separates the local oscillator (LO) into two equal amplitude signals, with 90-deg. phase difference between them (Fig. 2). The signal-splitting and limiting-amplification circuitry comprising the polyphase network is designed for optimum performance over a wide range of LO input power levels. LO signal paths are closely matched on chip to minimize phase offsets; the differential-mode transmission lines provide excellent immunity to noise. Each divided LO signal drives an active Gilbert-cell mixer, upconverting the IP/IN in-phase and QP/QN quadrature baseband data inputs, respectively. The upconverted IP/IN and QP/QN signals are then recombined in-phase, and converted from a balanced transmission line to a single-ended RF output.

The dynamic range of a direct quadrature modulator is critical in maintaining the integrity of digitally modulated signals. The dynamic range of a direct modulator can be defined as the ratio of its output power at 1-dB compression (in dBm) to its output noise floor (in dBm/Hz). The HMC495LP3 achieves output power at 1-dB compression of

| The HMC495LP3 direct modulator at a glance           |                 |
|--|-----------------|
| PARAMETER  | SPECIFICATION   |
| Frequency range                                      | 250 to 3800 MHz |
| Output power at 1-dB compression                     | 0 dBm           |
| Output third-order intercept                         | +13 dBm         |
| Output noise floor                                   | -158 dBm        |
| Carrier suppression (uncalibrated)                   | -34 dBc         |
| Sideband suppression (uncalibrated)                  | -28 dBc         |
| Third-order intermodulation suppression              | -50 dBc         |
| Typical ACPR for CDMA IS-95<br>(at 880 and 1960 MHz) | -72 dBc         |
| Typical ACPR for WCDMA 3GPP<br>(at 2140 MHz)         | -59 dBc         |

Note: Values are worst case for full band.

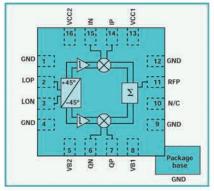
typically +2 dBm at 450 MHz and -2 dBm at 3800 MHz. The device's output noise floor is typically –157 dBm/Hz at 450 MHz and at 3800 MHz (Fig. 3), with the output noise floor measured at an offset of 20 MHz from the carrier, with supply voltage ( $V_{cc}$ ) of +3.3 VDC and baseband bias voltage ( $V_{DC}$ ) of +1.15 VDC. These values translate into a dynamic range of 155 to 159 dB across the 450-to-3800-MHz band.

Another important aspect of a direct quadrature modulator's performance is its sideband and carrier suppression, as well as its ability to control third-harmonic output levels. The HMC495LP3 direct quadrature modulator typically attains sideband and carrier suppression of  $-30~{\rm and}~-35~{\rm dBc}$ , respectively, with output third-harmonic distortion of  $-50~{\rm dBc}$  across the full band (see table). These suppression levels were measured for typical output power of  $-6~{\rm dBm}$ ,  $V_{\rm cc}$  of  $+3.3~{\rm VDC}$ , baseband frequency

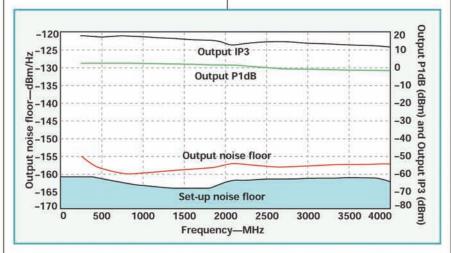
of 200 kHz at 800 mV peakto-peak differential, and baseband bias voltage of +1.15 VDC. In specific bands, the performance is often considerably better, with third-harmonic suppression of –59 dBc from 450 to 960 MHz and –56 dBc from 3400 to 3800 MHz (Fig. 4).

The high dynamic range of the HMC495LP3 is evident in its outstanding adjacent-chan-

nel-power-ratio (ACPR) performance under WCDMA conditions (Fig. 5). When driven to –14 dBm of WCDMA channel power at 2140 MHz, the HMC495LP3 provides ACPR performance of better than –59 dBc in both upper and lower adjacent channels. This performance is as good or better



 The HMC495LP3 direct quadrature modulator includes carefully matched signal paths with a pair of mixers offset by 90 deg.



This plot shows the output third-order-intercept point, output noise floor, and measurement setup noise floor as functions of frequency for the HMC495LP3.

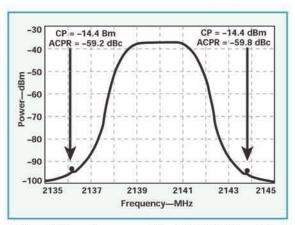
#### cover story

than other, more narrowband direct modulator RF ICs. Note that the WCDMA ACPR was measured at an offset of 3.84 MHz using a spectrum ana-

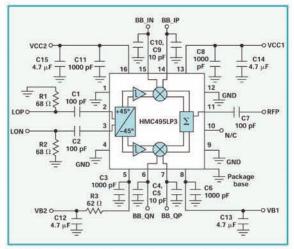
(dBc) (dBc) Output power suppr. -10 harmonic Sideband s), 3rd harmo -20 Sideband suppression -30 (dBc), (dBm). Carrier suppression 40 Carrier suppr. **Jutput** power -50 3rd harmonic 1500 2000 2500 3000 3500 4000 500 1000

4. The HMC495LP3's output power, sideband suppression, carrier suppression, and third-harmonic distortion are shown here as functions of frequency.

Frequency-MHz



5. The ACPR performance of the HMC495LP3 is plotted here under WCDMA signal conditions at 2140 MHz.



This schematic diagram shows a typical printed-circuit-board (PCB) application for the HMC495LP3 direct quadrature modulator.

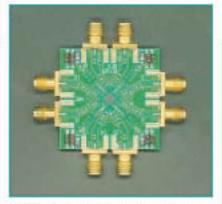
lyzer with 30-kHz resolution-bandwidth filters,  $V_{\rm cc}$  of +3.3 VDC, and baseband bias voltage of +1.15 VDC.

The versatile HMC495LP3 direct

quadrature modulator accepts a wide range of LO input power levels from -6 to +6 dBm, and delivers an extremely wide I and Q modulation bandwidth of DC to 250 MHz (in support of virtually all existing and many emerging modulation formats) when using the recommended 10-pF shunt capacitors. The HMC495LP3 will provide stable operation over a supply voltage range of +3.0 to +3.6 VDC, and a temperature range of -40 to +85°C.

The LO port of the HMC495LP3 can be driven in either single-ended or differential mode. Driving the LO port in singleended mode will eliminate the need for an external balun, the cost of which will depend on the frequency and bandwidth of operation. Driving the LO port in differential mode will improve the carrier suppression level by about 3 dB at 3500 MHz, although the relative improvement will be less at lower frequencies. Modulator carrier suppression can be improved by adjusting the DC offset in the I and Q input ports. The ideal DC offset of the I and Q signals depends on the final circuit layout, so the DC offset should be adjusted accordingly to correct for any slight asymmetries in the final circuit layout.

Similarly, the HMC495LP's sideband suppression can be optimized by adjusting the gain



7. This photograph shows a packaged HMC495LP3 mounted on one of the company's evaluation boards.

and phase offset between the I and O input ports. As with the carrier-suppression DC offset adjustment, the ideal gain and phase offset between the I and Q signals depends on the actual application circuit.

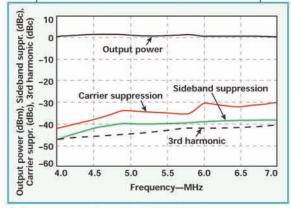
The HMC495LP3 can be used to create virtually any analog- or digitalmodulation format including binary

phase-shift keying (BPSK), quadrature phase-shift keying (QPSK), eight-state phase-shift keying (8PSK), orthogonal frequencydivision multiplex (OFDM), and quadrature amplitude modulation (QAM). The direct quadrature modulator's wide bandwidth and low noise floor make it a suitable choice for base-station, access point, and customer-premisesequipment (CPE) applications in the cellular, personal-communications-services (PCS), UMTS, fixed wireless, and Hiper-LAN/HiperMAN WLAN bands. This wideband capability allows the transceiver designer to use a common printed-circuit-board (PCB) design for multiple frequency bands. The HMC495LP3 is also well suited for applications in software-defined radios (SDRs) where the upconverter must dynamically vary its modulation format depending on changing conditions and requirements (Fig. 6).

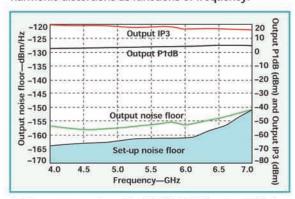
in this article, data were taken applied to the HMC495LP's LOP noise as functions of frequency.

port, with the LON port terminated to ground through a  $50-\Omega$  resistor (Fig. 7). A shunt  $68-\Omega$  resistor is used on each of the LON and LOP ports to improve LO port return loss, while a 100pF series capacitor prevents DC voltage from appearing on the application PCB.

The HMC495LP3 has two supply and two bias input lines. To reduce any power-supply noise, each of these lines is decoupled by shunt 4.7-µF capacitors placed close to the input connector, and shunt 1000-pF capacitors placed in close proximity to the  $3 \times 3$ -mm package. The nominal supply voltage for  $V_{cc1}$  and  $V_{cc2}$  is +3.3 VDC. Voltage  $V_{
m bb1}$  is tied to  $V_{
m cc}$ , while the  $V_{
m bb2}$  voltage is dropped to +3.0 VDC through a series  $62-\Omega$  resistor; this reduction in  $V_{\rm bb2}$ will improve the sideband suppression and output noise, while reducing the overall power consumption. The RF output of the HMC495LP3 is single ended and



8. These curves show the HMC496LP3's output power, sideband suppression, carrier suppression, and thirdharmonic distortions as functions of frequency.



For the measurements shown 9. These curves show the HMC496LP3's output thirdorder intercept point, output power at 1-dB compreswith a single-ended LO source sion, output noise floor, and measurement setup

a series 100-pF capacitor is used for DC blocking.

The IP/IN and QP/QN ports of the HMC495LP3 are DC coupled to allow modulation frequencies down to DC. All four ports are shunted to ground with a 10-pF capacitor. This capacitance value was chosen for a low impedance to ground at the LO frequency, in order to improve the carrier suppression and to filter noise. The HMC495LP's modulation bandwidth can be increased beyond 250 MHz by removing these capacitors or reducing their values.

In addition to the HMC495LP3, the company has also announced the HMC496LP3 4.0-to-7.0-GHz SiGe direct modulator for higher-frequency applications. It offers typically -39 dBc sideband suppression and -35 dBc carrier suppression, with third-harmonic intermodulation levels of typically -44 dBc (Fig. 8). These suppression levels

> were measured with typical output power of +3 dBm, V<sub>cc</sub> of +3.0 VDC, baseband frequency of 200 kHz at 1.2 V peak-to-peak differential voltage and  $V_{dc}$  of +1.3 VDC.

> The HMC496LP3 achieves output power at 1-dB compression of typically +3 dBm at 4.0 GHz and +4 dBm at 6.0 GHz. The output noise floor is typically -157 dBm in a 1-Hz bandwidth from 4.0 to 6.0 GHz (Fig. 9), when measured at an offset of 20 MHz, with  $V_{cc}$  of +3.0 VDC and  $V_{dc}$  of +1.3 VDC. These values translate into a dynamic range of approximately 160 dB from 4.0 to 6.0 GHz.

> Both the HMC495LP3 and the HMC496LP3 wideband SiGe direct quadrature modulators are available from stock. Complete specifications can be found on the company's website. The company also offers evaluation boards fabricated on high-performance 4350 PCB material from Rogers Corp. (Rogers, CT) with SMA connectors for ease of testing. Hittite Microwave Corp., 12 Elizabeth Dr., Chelmsford, MA 01824; (978) 250-3343, FAX: (978) 250-3373, Internet: www.hittite.com.